

$I_{F(AV)} = 40\text{Amp}$
 $V_R = 45\text{V}$

Major Ratings and Characteristics


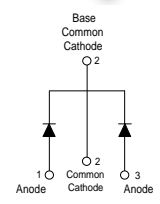

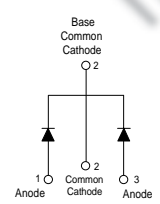
Characteristics	Values	Units
$I_{F(AV)}$ Rectangular waveform (Per Device)	40	A
I_{FRM} @ $T_C = 118^\circ\text{C}$ (PerLeg)	40	A
V_{RRM}	45	V
I_{FSM} @ $t_p = 5\ \mu\text{s}$ sine	900	A
V_F @ $20\text{Apk}, T_J = 125^\circ\text{C}$	0.58	V
T_J range	-65 to 150	$^\circ\text{C}$

Description/Features

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150°C junction temperature. Typical applications are in switching power supplies, converters, free-wheeling diodes, and reverse battery protection.

- 150°C T_J operation
- Center tap TO-220, D²Pak and TO-262 packages
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Lead-Free ("PbF" suffix)

Case Styles

<p>MBRB4045CTPbF</p>   <p>D²PAK</p>	<p>MBR4045CT-1PbF</p>   <p>TO-262</p>
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Voltage Ratings

Parameters	MBRB4045CTPbF, MBR4045CT-1PbF
V _R Max. DC Reverse Voltage (V)	45
V _{RWM} Max. Working Peak Reverse Voltage (V)	

Absolute Maximum Ratings

Parameters	Values	Units	Conditions
I _{F(AV)} Max. Average Forward Current (Per Leg) (Per Device)	20	A	@ T _C = 118° C, (Rated V _R)
	40		
I _{FRM} Peak Repetitive Forward Current (Per Leg)	40	A	Rated V _R , square wave, 20kHz T _C = 118° C
I _{FSM} Max. Peak One Cycle Non-Repetitive Surge Current (Per Leg)	900	A	5µs Sine or 3µs Rect. pulse 10ms Sine or 6ms Rect. pulse Following any rated load condition and with rated V _{RRM} applied
	210		
E _{AS} Non-Repetitive Avalanche Energy (Per Leg)	20	A	T _J = 25° C, I _{AS} = 3Amps, L = 4.40mH
I _{AR} Repetitive Avalanche Current (Per Leg)	3	A	Current decaying linearly to zero in 1 µsec Frequency limited by T _J max. V _A = 1.5 x V _R typical

Electrical Specifications

Parameters	Values	Units	Conditions
V _{FM} Max. Forward Voltage Drop (1)	0.60	V	@ 20A T _J = 25° C
	0.78	V	@ 40A
	0.58	V	@ 20A T _J = 125° C
	0.75	V	@ 40A
I _{IRM} Max. Instantaneous Reverse Current (1)	1	mA	T _J = 25° C Rated DC voltage
	50	mA	T _J = 100° C
	95	mA	T _J = 125° C
C _T Max. Junction Capacitance	900	pF	V _R = 5V _{DC} (test signal range 100Khz to 1Mhz) 25° C
L _S Typical Series Inductance	8.0	nH	Measured from top of terminal to mounting plane
dv/dt Max. Voltage Rate of Change	10000	V/µs	(Rated V _R)

(1) Pulse Width < 300µs, Duty Cycle < 2%

Thermal-Mechanical Specifications

Parameters	Values	Units	Conditions
T _J Max. Junction Temperature Range	-65 to 150	°C	
T _{stg} Max. Storage Temperature Range	-65 to 175	°C	
R _{thJC} Max. Thermal Resistance Junction to Case (Per Leg)	1.5	°C/W	DC operation
R _{thCS} Typical Thermal Resistance Case to Heatsink	0.50	°C/W	Mounting surface, smooth and greased Only for TO-220
R _{thJA} Max. Thermal Resistance Junction to Ambient	50	°C/W	DC operation For D ² Pak and TO-262
wt Approximate Weight	2 (0.07)	g (oz.)	
T Mounting Torque	Min. 6 (5)	Kg-cm (lbf-in)	Non-lubricated threads
	Max. 12 (10)		
Device Marking	MBRB4045CT	Case style D ² Pak	
	MBR4045CT-1	Case style TO-262	

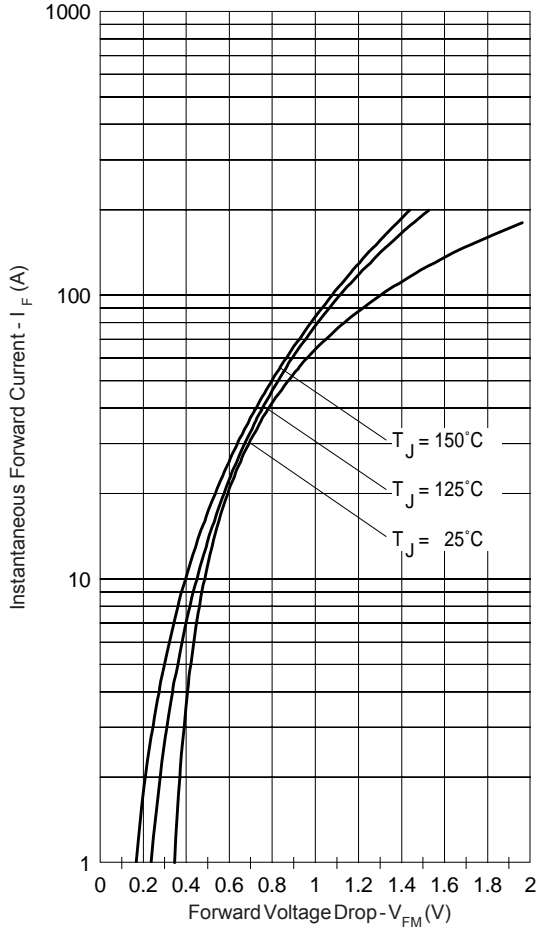


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

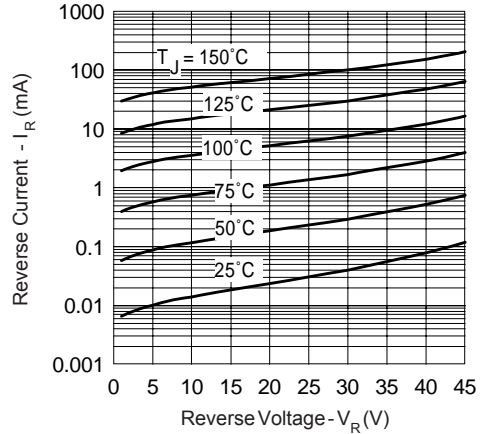


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage (Per Leg)

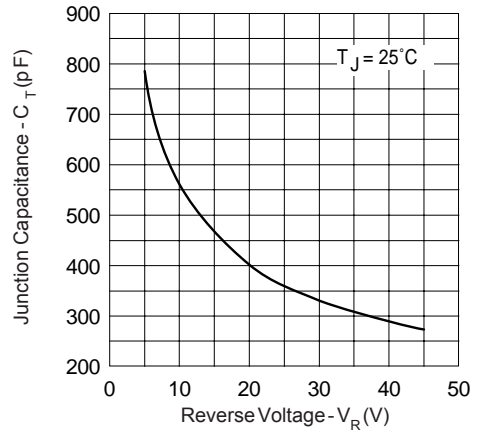


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

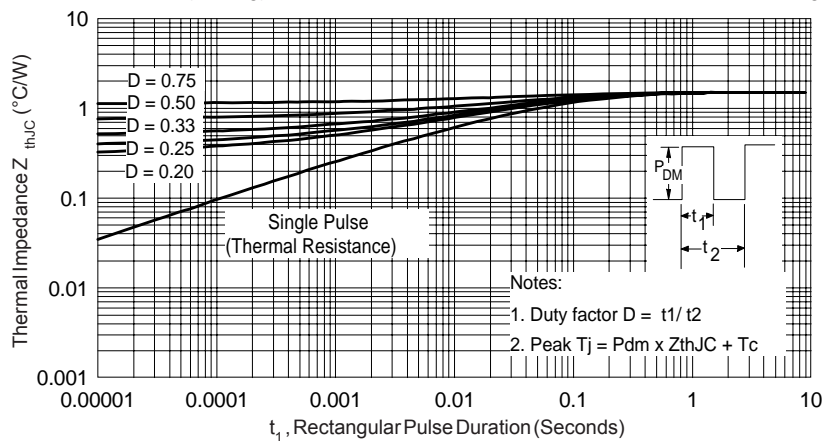


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

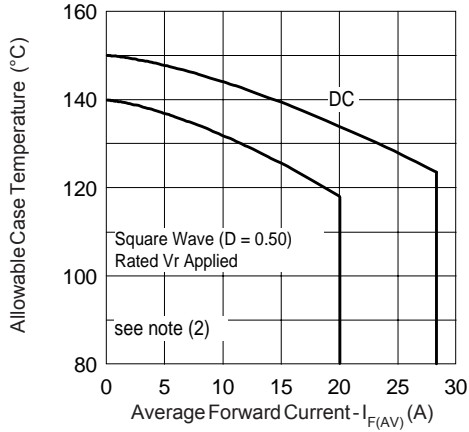


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current

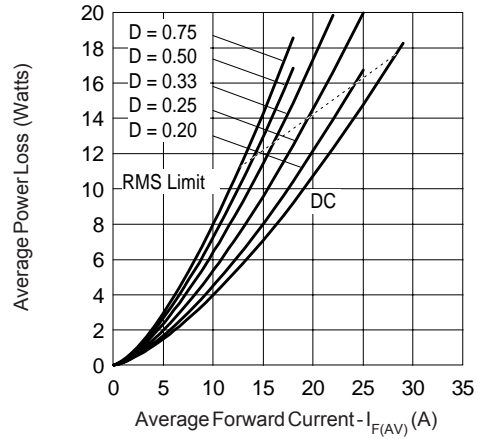


Fig. 6 - Forward Power Loss Characteristics

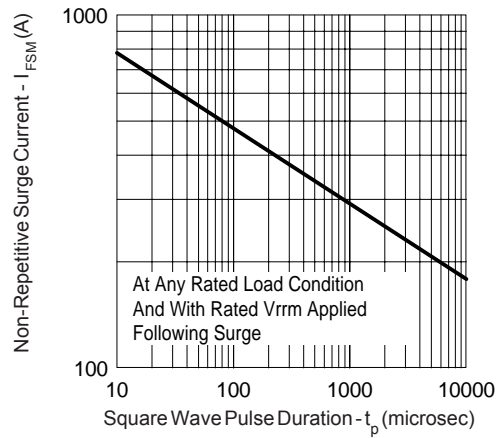


Fig. 7 - Max. Non-Repetitive Surge Current (Per Leg)

(2) Formula used: $T_c = T_j - (Pd + Pd_{REV}) \times R_{thJC}$

$Pd = \text{Forward Power Loss} = I_{F(AV)} \times V_{FM} @ (I_{F(AV)} / D)$ (see Fig. 6);

$Pd_{REV} = \text{Inverse Power Loss} = V_{R1} \times I_R (1 - D)$; $I_R @ V_{R1} = \text{rated } V_R$

Outlines Table

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES]
 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
 4. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
 5. CONTROLLING DIMENSIONS: INCH.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	
A1	0.00	0.254	.000	.010	
b	0.51	0.99	.020	.039	4
b1	0.51	0.89	.020	.035	4
b2	1.14	1.78	.045	.070	
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	4
c2	1.14	1.65	.045	.065	
D	8.51	9.65	.335	.380	3
D1	6.86		.270		
E	9.65	10.67	.380	.420	3
E1	6.22		.245		
e	2.54	BSC	.100	BSC	
H	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1		1.65	.065		
L2	1.27	1.78	.050	.070	
L3	0.25	BSC	.010	BSC	
L4	4.78	5.28	.188	.208	
m	17.78		.700		
m1	8.89		.350		
n	11.43		.450		
o	2.08		.082		
p	3.81		.150		
R	0.51	0.71	.020	.026	
θ	90°	93°	90°	93°	

LEAD ASSIGNMENTS

HEXFET
 1.- GATE
 2, 4.- DRAIN
 3.- SOURCE

IGBTs, CoPACK
 1.- GATE
 2.- COLLECTOR
 3.- EMITTER

DIODES
 1.- ANODE *
 2, 4.- CATHODE
 3.- ANODE

* PART DEPENDENT.

Conform to JEDEC outline D²Pak (SMD-220)
 Dimensions in millimeters and (inches)

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES]
 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
 5. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
 6. CONTROLLING DIMENSIONS: INCH.
 7.- OUTLINE CONFORM TO JEDEC TO-262 EXCEPT A1(max.), b1(min.) AND D1(min.) WHERE DIMENSIONS DERIVED THE ACTUAL PACKAGE OUTLINE.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	
A1	2.03	3.02	.080	.119	
b	0.51	0.99	.020	.039	5
b1	0.51	0.89	.020	.035	5
b2	1.14	1.78	.045	.070	
b3	1.14	1.73	.045	.068	
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	5
c2	1.14	1.65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86		.270		4
E	9.65	10.67	.380	.420	3,4
E1	6.22		.245		4
e	2.54	BSC	.100	BSC	
L	13.46	14.10	.530	.555	
L1		1.65		.065	4
L2	3.56	3.71	.140	.146	

LEAD ASSIGNMENTS

HEXFET
 1.- GATE
 2.- DRAIN
 3.- SOURCE
 4.- DRAIN

IGBTs, CoPACK
 1.- GATE
 2.- COLLECTOR
 3.- EMITTER
 4.- COLLECTOR

Modified JEDEC outline TO-262
 Dimensions in millimeters and (inches)

Part Marking Information

D²PAK

EXAMPLE: THIS IS A MBRB3045CT
LOT CODE 8024
ASSEMBLED ON WW 02, 2000

Note: "P" in assembly line position indicates "Lead-Free"

INTERNATIONAL RECTIFIER LOGO
ASSEMBLY LOT CODE
PART NUMBER
DATE CODE
YEAR 0 = 2000
WEEK 02
P = LEAD-FREE

TO-262

EXAMPLE: THIS IS A MBR4045CT-1
LOT CODE 1789
ASSEMBLED ON WW 19, 2002

Note: "P" in assembly line position indicates "Lead-Free"

INTERNATIONAL RECTIFIER LOGO
ASSEMBLY LOT CODE
PART NUMBER
DATE CODE
YEAR 2 = 2002
WEEK 19
P = LEAD-FREE

Tape & Reel Information

SECTION Y-Y

Ao	10.50	+/- 0.1
Bo	15.80	+/- 0.1
B2	10.25	+/- 0.1
Ko	4.90	+/- 0.1
F	11.50	+/- 0.1
P1	16.00	+/- 0.1
W	24.00	+/- 0.3

NOTES:

- 1.0 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ± 0.02
- 2.0 CAMBER NOT TO EXCEED 1mm in 100mm
- 3.0 MATERIAL: CONDUCTIVE BLACK STYRENIC ALLOY
- 4.0 Ko MEASURED FROM A PLANE ON THE INSIDE BOTTOM OF THE POCKET TO THE TOP SURFACE OF THE CARRIER
- 5.0 MEASURED FROM CENTRELINE OF SPROCKET HOLE TO CENTRELINE OF POCKET
- 6.0 VENDOR: (OPTIONAL)
- 7.0 MUST ALSO MEET REQUIREMENTS OF EIA STANDAR #EIA-481A TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC PLACEMENT
- 8.0 SURFACE RESISTIVITY OF MOLDED MATL. MUST MEASURE LESS OR EQUAL TO 10^6 OHMS PER SQUARE. MEASURED IN ACCORDANCE TO PROCEDURE GIVEN IN ASTM D-257 & ASTM D-991
- 9.0 TOTAL LENGTH PER REEL MUST BE 45 METERS
- 10.0 © CRITICAL

Dimensions in millimeters and (inches)

Ordering Information Table

Device Code																	
	<table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <td style="padding: 5px;">MBR</td> <td style="padding: 5px;">B</td> <td style="padding: 5px;">40</td> <td style="padding: 5px;">45</td> <td style="padding: 5px;">CT</td> <td style="padding: 5px;">-1</td> <td style="padding: 5px;">TRL</td> <td style="padding: 5px;">PbF</td> </tr> <tr> <td style="text-align: center;">①</td> <td style="text-align: center;">②</td> <td style="text-align: center;">③</td> <td style="text-align: center;">④</td> <td style="text-align: center;">⑤</td> <td style="text-align: center;">⑥</td> <td style="text-align: center;">⑦</td> <td style="text-align: center;">⑧</td> </tr> </table>	MBR	B	40	45	CT	-1	TRL	PbF	①	②	③	④	⑤	⑥	⑦	⑧
MBR	B	40	45	CT	-1	TRL	PbF										
①	②	③	④	⑤	⑥	⑦	⑧										
1	- Essential Part Number																
2	- B = Surface Mount																
3	- Current Rating (40 = 40A)																
4	- Voltage code (45 = 45V)																
5	- CT = Essential Part Number																
6	- "-1" = TO-262																
7	- <ul style="list-style-type: none"> • none = Tube (50 pieces) • TRL = Tape & Reel (Left Oriented - for D²Pak only) • TRR = Tape & Reel (Right Oriented - for D²Pak only) 																
8	- <ul style="list-style-type: none"> • none = Standard Production • PbF = Lead-Free 																

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MBR4045CT
*****
*      This model has been developed by      *
*      Wizard SPICE MODEL GENERATOR (1999)  *
*      (International Rectifier Corporation) *
*      Contains proprietary Information      *
*****
* SPICE Model Diode is composed by a      *
* simple diode plus paralalled VCG2T      *
*****
.SUBCKT MBR4045CT ANO CAT
D1 ANO 1 DMOD (0.07089)
*Define diode model
.MODEL DMOD D(IS=1.41031849705903E-04A,N=1.12223892649545,BV=49V,
+ IBV=0.267178064395486A,RS= 0.000581298,CJO=2.94926944579954E-08,
+ VJ=0.779269989906853,XTI=2, EG=0.730300626417364)
*****
*Implementation of VCG2T
VX 1 2 DC 0V
R1 2 CAT TRES 1E-6
.MODEL TRES RES(R=1,TC1=19.7716341798827)
GP1 ANO CAT VALUE={-ABS(I(VX))*(EXP((( -2.531689E-03/19.77164)*(V(2,CAT)*1E6)/
(I(VX)+1E-6)-1))+1)*6.454822E-02*ABS(V(ANO,CAT)))-1}
*****
.ENDS MBR4045CT

Thermal Model Subcircuit
.SUBCKT MBR4045CT 5 1

CTHERM1      5      4      1.84E+00
CTHERM2      4      3      1.74E+01
CTHERM3      3      2      9.36E+01
CTHERM4      2      1      1.30E+03

RTHERM1      5      4      4.55E-01
RTHERM2      4      3      5.76E-01
RTHERM1      3      2      3.12E-01
RTHERM1      2      1      1.49E-01

.ENDS MBR4045CT
    
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Data and specifications subject to change without notice.
 This product has been designed and qualified for Industrial Level and Lead-Free.
 Qualification Standards can be found on IR's Web site.



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